## CABLINE ${ }^{\circledR}$-VSF

Mechanical lock, 0.5 mm pitch, Horizontal mating type FPC plug connector

| Product Specifications: |  |  | Applicable FPC |  |
| :---: | :---: | :---: | :---: | :---: |
| Mating type |  | Horizontal | FPC Type | Shielded/Non-shielded FPC |
| Board Pitch (mm) |  | 0.5 | FPC Pitch (mm) | 0.5 |
| Wiping Length (mm) |  | 0.62 | FPC Contact Point | Top |
| $\begin{aligned} & \text { Mated size } \\ & \quad(\mathrm{mm}) \end{aligned}$ | Height | 1.0 +/- 0.1 | FPC Thickness (mm) | Contact Area: $0.28+0.02 /-0.03$ |
|  | Width | Formula: $7.55+(0.5 *$ ?p) |  | Ground Area: $0.34 \pm 0.05$ |
|  | Depth | 5.97 | Applicable Standards (Reference Only): |  |
| Pin Counts | Range | Up to 50 | PCle ${ }^{\circledR}$ Gen 4 ( $16 \mathrm{GT} / \mathrm{s} /$ Lane), USB3.2 Gen2 (10 Gbps/Lane) eDP HBR 3 (8.1 Gbps/Lane), USB3.2 Gen1(5 Gbps/Lane) |  |
|  | Available | 30, 40 |  |  |

Mechanical Locking Bar Prevents Incomplete Mating and Back-out/Un-mating


Interference
Mechanical locking bar can be locked only when plug is fully mated to receptacle.


Incomplete mating


Complete mating

## EMI Shielding and Multi-point Ground Design



## Multiple Connector Options with I-PEX VS Series

I-PEX VS series ( 0.5 mm pitch, horizontal mating type) CABLINE-VS, VS II receptacles and EVAFLEX ${ }^{\circledR}$ 5-VS can be mounted to the same PCB layout.

CABLINE-VS Receptacle:
Has No. 1 share in the Notebook PC panel connector market as VESA standard connector.


## Component Parts Details

## Component Parts


WITHOUT LOCK BAR TYPE

## Shell Assembly

| Recommended P/N 20645-0**T-0 |
| :--- | :--- |


| PART No. | A | B | C |
| :---: | :---: | :---: | :---: |
| $20645-030 \mathrm{~T}-01$ | 19.30 | 17.56 | 20.05 |
| $20645-040 \mathrm{~T}-01$ | 24.30 | 22.56 | 25.05 |





| 2 | LOCK BAR | Sus | - |
| :---: | :---: | :---: | :---: |
| 1 | SHELL | PHOSPHOR BRONZE | ALL OVER Ni $1.00 \mu \mathrm{~m}$ MIN. CONTACT \& SOLDERING AREA: Au $0.01 \mu \mathrm{~m}$ MIN. |
| NO. | DISCRIPTION | MATERIAL | FINISH, REMARKS |

FPC ASS'Y STATE



DETAIL BB
$\frac{\text { DETAIL BB }}{(\mathrm{S}=20 / 1)}$


## Shell Assembly




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$\frac{\text { DEFANDD }}{(\mathrm{S}=15 / 1 \mathrm{l}}$


NOTES.

1. ADHESIVE SHOULD USE THERMOSETTING.
. No.6:CONDUCTOR(GROUND) AND No.8:CONDUCTOR(GROUND) ARE CARRYING OUT THE ELECTRICAL CONNECTION.
. No. : SHIELD FILM AND No. 8: CONDUCTOR(GROUND) ARE CARRYING OUT THE ELECTRICAL CONNECTION.
2. No.5: CONDUCTOR(SIGNAL) AND No.6.8: CONDUCTOR(GROUND) ARE NOT CONTACTING.
3. No.5:CONDUCTOR(SIGNAL) AND No.3:SHIELD FILM ARE NOT CONTACTING.




NOTES.
6. ADHESIVE SHOULD USE THERMOSETTING.
7. No. 12:CONDUCTOR(SIGNAL) AND No. 13 :CONDUCTOR(GROUND) ARE NOT CONTACTING.

| ITEMS | SPECIFICATION |
| :---: | :---: |
| RATING VOLTAGE | 100V AC (PER CONTACT) |
| RATING AMPERAGE (FOR SIGNAL CONTACT) | 0.5A AC/DC (PER CONTACT PIN) ※AVAILABLE UP TO 20PIN $0.3 \mathrm{~A} \mathrm{AC/DC}$ (PER CONTACT PIN) ※AVAILABLE FOR ALL PIN |
| OPERATING TEMPERATURE | $233 \sim 358 \mathrm{~K}\left(-40^{\circ} \mathrm{C} \sim+85^{\circ} \mathrm{C}\right)$ |
| OPERATING HUMIDITY | 85\% MAX (NON-CONDENSING) |
| CONTACT RESISTANCE (FOR SIGNAL CONTACT) | INITIAL : $60 \mathrm{mohm} \mathrm{MAX}. \mathrm{/} \mathrm{AFTER} \mathrm{TEST} \mathrm{:} \triangle 40 \mathrm{mohm} \mathrm{MAX}$. |
| GROUND SHELL RESISTANCE | INITIAL : 60 mohm MAX. / AFTER TEST : $\triangle 40 \mathrm{mohm} \mathrm{MAX}$. |
| INSULATION RESISTANCE | INITIAL : $1000 \mathrm{Mohm} \mathrm{MIN}. \mathrm{/} \mathrm{AFTER} \mathrm{TEST} \mathrm{:} 500 \mathrm{Mohm} \mathrm{MIN}$. |
| DIELECTRIC WITHSTANDING VOLTAGE | AC250V 1 min |
| DURABILITY | 30 CYCLES |
| MATING FORCE (INITIAL / AFTER TEST) | $30 \mathrm{P}: 24.0 \mathrm{~N} \mathrm{MAX} / 40 \mathrm{P}: 32.0 \mathrm{~N} \mathrm{MAX}$. |
| UNMATING FORCE (INITIAL / AFTER TEST) | $30 \mathrm{P}: 1.1 \mathrm{~N} \mathrm{MIN} . / 40 \mathrm{P}: 1.4 \mathrm{~N}$ MIN. |
| PRODUCT SPECIFICATION | PRS-1878 |
| TEST REPORT | TR-14095, TR-17048 |
| PACKING STANDARD | PST-14087 |
| INSTRUCTION MANUAL | HIM-13010 |
| ASSEMBLY MANUAL | ASM-13003 |
| APPEARANCE CRITERIA No. | QLS-A*** |

## Receptacle Assembly



## Receptacle Assembly

| Recommended P/N | $20455-0 * * E-76(30 \mathrm{P} / 40 \mathrm{P} / 50 \mathrm{P})$ | 20455-A20E-76(20P) |
| :--- | :--- | :--- | :--- |



TYPE-A

A: TYPE-A -



$\frac{\text { SECT } X-X}{S=10-1}$


IABLE. 2

| PART NO. | DATUM MARK | CONTACT FINISH | SHELL FINISH |
| :---: | :---: | :---: | :---: |
| 20455-A.20E-02 | WITH | CONTACT AREA <br> Au $0.1 \mu \mathrm{~m}$ MIN. OVER Ni $1.00 \mu \mathrm{~m}$ MIN. <br> SOLDERING AREA <br> Au $0.05 \mu \mathrm{~m}$ MIN. OVER Ni $1.00 \mu \mathrm{~m}$ MIN. | Au $0.02 \mu \mathrm{~m}$ MIN. OVER ${ }^{\text {N }} 1.00 \mu \mathrm{~mm}$ MN. |
| 20455-A.20E-12 | WITHOUT |  |  |
| 20455-A20E-66 | WITH | CONTACT AREA <br> Au $0.1 \mu \mathrm{~m}$ MIN. OVER Ni $1.00 \mu \mathrm{~m}$ MIN. <br> SOLDERING AREA <br> AL $0.05 \mu \mathrm{~m}$ MIN. OVER Ni $1.00 \mu \mathrm{~m}$ MIN | Au $0.01 \mu \mathrm{~m}$ MN. OVER $\mathrm{Ni} 1.00 \mu \mathrm{~m}$ M $\mathrm{NN}^{\text {. }}$ |
| 20455-A20E-76 | WITHOUT |  |  |


| 3 | SHELL | PHOSPHOR BRONZE | SEE ABOVE TABLE. 1 |
| :---: | :--- | :--- | :--- |
| 2 | CONTACT | PHOSPHOR BRONZE | SEE ABOVE TABLE. 1 |
| 1 | HOUSING | LCP | UL94V-0, BLACK |
| NO. | DISCRIPTION | MATERIAL | FINISH, REMARKS |



NOTES.

1. IN CASE OF PLUG WITH PULL-BAR, DO NOT MOUNT ANOTHER COMPONENT IN THIS AREA
2. SOLDER RESIST MUST BE APPLIED TO THIS AREA.

## Receptacle Assembly



CONNECTOR ON RECOMMENDED FOOTPRINT PATTERN P/N: 20455-0**E-\#\#


CONNECTOR ON RECOMMENDED FOOTPRINT PATTERN P/N:20455-A20E-


SENJU METAL REFLOW TEMPERATURE PROFILE SENJU METAL INDUSTRY CO., LTD. : M705-SHF(Sn96.5 Ag3.0 Cu0.5)

## Custom Connectors Available

## Divata Optical

 Module
## LIGHTPASS ${ }^{\circledR}$ series



Micro-coaxial/Twinax/
Discrete Wire Connector

